LIDIC COMPETITIEF ELECTRONICA ONTWERP EN ASSEMBLAGE DICHT BIJ DE KLANT



GEERT WILLEMS – IMEC - ELECTRONIC ASSEMBLY CENTER FOR ELECTRONICS DESIGN AND MANUFACTURING



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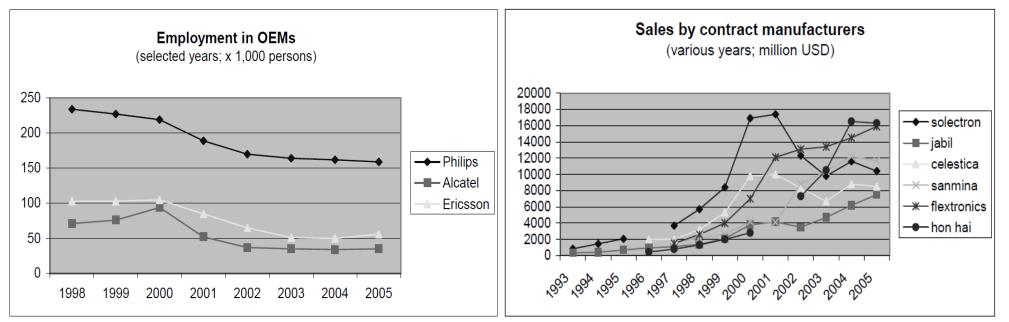
- 20th Century Manufacturing Outsourcing
- Outlook 2017
- Drivers for Re-shoring
- What is needed for local design & manufacturing?
- A scientific approach to electronics design & manufacturing

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THE 20TH CENTURY MANUFACTURING OUTSOURCING THE TREND



- Focus on the core business
- Low cost electronics manufacturing by EMS:



THE 20TH CENTURY MANUFACTURING OUTSOURCING 20 YEARS OF ELECTRONICS OUTSOURCING

The result

- Electronics is everywhere
- China: The world's factory
- US-Europe: major decline in manufacturing activity and know-how ...
 ... needed for cost effective, qualitative product development
- Highly complex and fragmented supply chain
- Declining quality and reliability
- Counterfeit: >10% of electronic components
- Copyright \rightarrow "The right to copy"
- Slow response speed to customer driven changes.
- A lot of hidden costs: non-quality, communication, engineering changes, design iterations,...
- Transport: cost, environment



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OUTLOOK 2017 - INDUSTRY "THE TIMES THEY ARE A-CHANGIN' "?



Foxconn Is Coming to America: Has Offshoring Peaked? Bolaji Ojo | January 28, 2014 | 1 Comment

Manufacturing Comes Back to United States Terry Costlow, IPC online editor September 2, 2013

Is Nearshoring Right for Your Product?

JULY 2012

As China matures, a host of factors could rebalance the geographical supply chain.

Is Reshoring A Viable Option?

Tue, 01/21/2014 - 9:58am

by Tia Nowack, Associate Editor, Industrial Maintenance & Plant Operation

Reshoring vaak startsein voor innovatie

By Donata van de Ven september 2, 2016



China's Evaporating Manufacturing Cost Advantage Leading to US Reshoring By: David Russell Schilling | April 6th, 2017

HOW RESHORING DRIVES PROFITABILITY

This paper was originally published in the IPC APEX EXPO 2015 technical conference program.

Domestic Versus Offshore PCB Manufacturing

SUNSTONE* 'Made in USA" @2013

The Trend Away From Offshore PCB Manufacturing

Must manufacturing leave Europe?

Electronic Engineering Times Europe November 2013

Manufacturers' MONTHLY



"Raspberry Pi has shown that with the right product addressing a global market European manufacturing not only makes sense, but can show a lead to the world."

Re-shoring tide is starting to turn

October 27, 2016 Alan Johnson

More: <u>http://reshoringmfg.com/</u>



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OUTLOOK 2017 - US "THE TIMES THEY ARE A-CHANGIN' "?





Why the U.S. is now winning the fight to keep manufacturing jobs onshore Article by Bart Taylor May 8, 2017, 09:28 am MDT

In 2014 and 2015 parity was reached between offshoring and returning jobs, indicating that the net bleeding of manufacturing jobs to offshore had stopped. As of 2016, for the first time, probably since the 1970s, there was a net positive gain in U.S. jobs. The U.S. has gone from losing about 220,000 manufacturing jobs per year at the beginning of the last decade, to adding 30,000 jobs in 2016.

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OUTLOOK 2017 - EUROPE "THE TIMES THEY ARE A-CHANGIN' "?





Briefing 21/03/2014

Reshoring of EU manufacturing

MANUFACTURING towards 20% GDP by 2020

Factories of the Future – Industry 4.0 Horizon 2020 "Industrial Leadership" category 2014-2020: **€17 billion**





European Reshoring Monitor

https://reshoring.eurofound.europa.eu/

ERM annual report 2016: Globalisation slowdown? Recent evidence of offshoring and reshoring in Europe

https://www.eurofound.europa.eu/publications/executivesummary/2017/erm-annual-report-2016-globalisation-slowdown-recentevidence-of-offshoring-and-reshoring-in-europe

Manufacturing in EU 2016: 15% GDP 33 million employees



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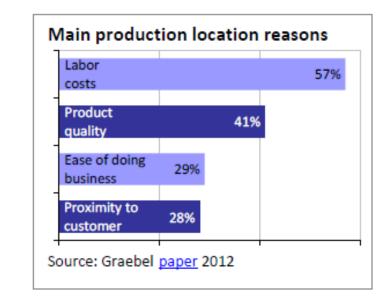
DRIVERS FOR RE-SHORING

Industry

- Rising total landed cost
 - Increasing labour cost
 China: +10%/y ('00-'05) +19%/y ('06-'10)
 +15%/y on-going
 - Increasing transport costs: oil x3 since '00
 - Cost of (larger) inventory

Product quality

- Intellectual Property
- Ease of doing business
- Proximity to customers
- Mitigate supply risk



Governements

Jobs: I manufacturing job + 2.5 support

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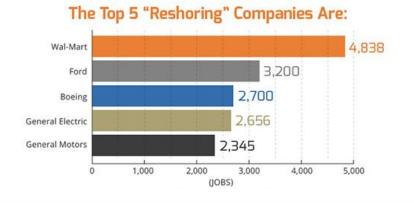
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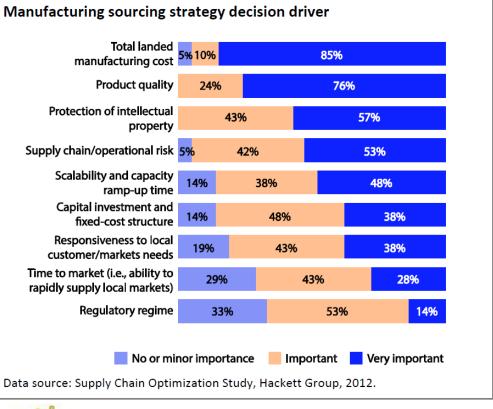
- Higher pay than service sector
- More R&D \rightarrow innovation, IP
- More export, less import



MOST LIKELY PRODUCTS TO BE RE-SHORED

- "Dynamic" goods subject to frequent changes in consumer demand and short product life-cycles
- Expensive to transport: ex. Heavy machinery
- Products where safety concerns are important









WHAT IS NEEDED?

Product:

- Dynamical
- Quality
- Safety \rightarrow reliable
- High value

FLEXIBLE AUTOMATION reduce labour - increase quality FAST Right-First-Time Product development PRODUCT RELIABILITY

PRODUCT LIFE CYCLE CONTROL

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ED&A CASE: WHY START IN-HOUSE MANUFACTURING?

Sok / yr - 2 + ER FASTER variation & Design-fre COSite of the second se





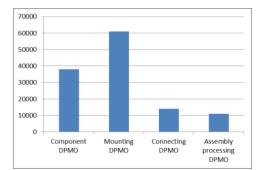




New Quality method achievements

- 4 to 6 times better PCBA quality in 3 years
- Manufacturing Risks have become transparent

EDM Workshop 20, December 9, 2014



After decades of constant PCBA quality we have been able to improve it at our suppliers by a factor 4 to 6 in 3 years time by deploying the new Quality Quantification methodology embedded in imec's **<u>Pred-X</u>** tool in **ASML**'s New Product Introduction process. Further quality improvement using this method at system level is the aim of ASML's ZHDR project. www.movip.nl – www.cedm.be



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WHAT IS NEEDED?

COMPETITIVE LOCAL MANUFACTURING

- Manufacturing knowledge PCB & assembly @ design: materials, processes, structure It is feasible. It is not "rocket-science".
- Design-for-Manufacturing:
 - Quantitative modeling not just "by experience"
 - Guidelines & tools
 - DfM & DfAssembly: design evaluation
- Manufacturing automation:
 - Placement equipment robotization
 - Component feeders
 - Tracking & tracing Industry 4.0 IoT in the factory small batch optimization
- Data standardization and data cleansing



WHAT IS NEEDED?

Product:

- Dynamical
- Quality
- Safety \rightarrow reliable
- High value

Design-for-eXcellence Manufacturing plus Reliability, Logistics, Cost,...

Trustworthy PREDICTION of all Product Life Cycle aspects (without costly, long duration prototyping & testing)

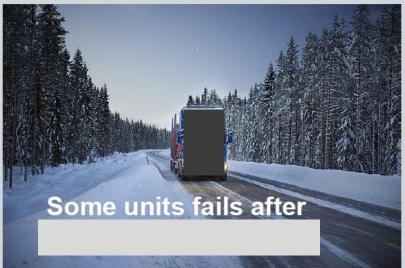
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Challenge:

In the US – and in parts of Europe – there is difficulty in finding suitably skilled labour, reflecting the education system and a loss of specific manufacturing know-how, which has passed to new countries.

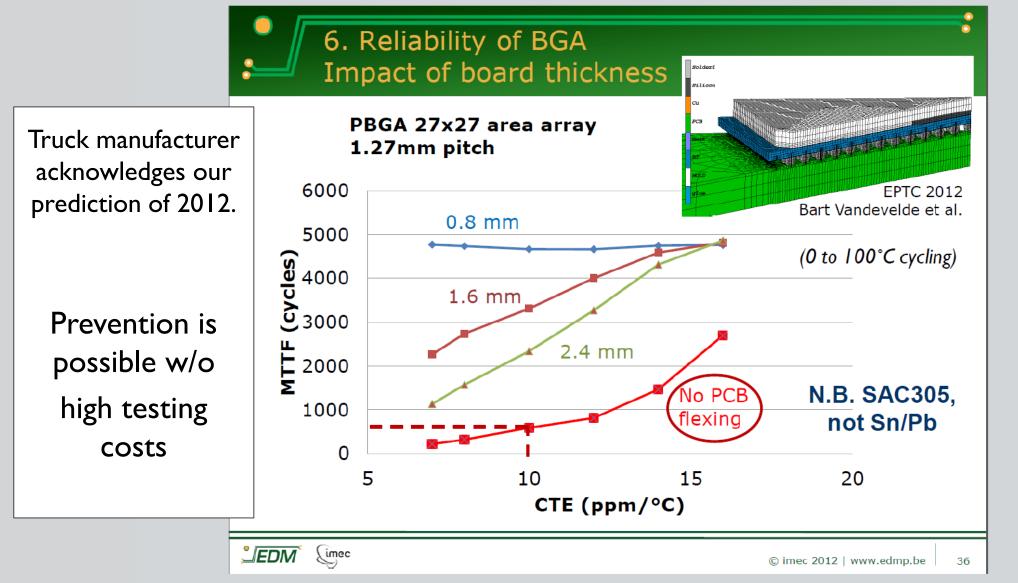


ECU



2016 report



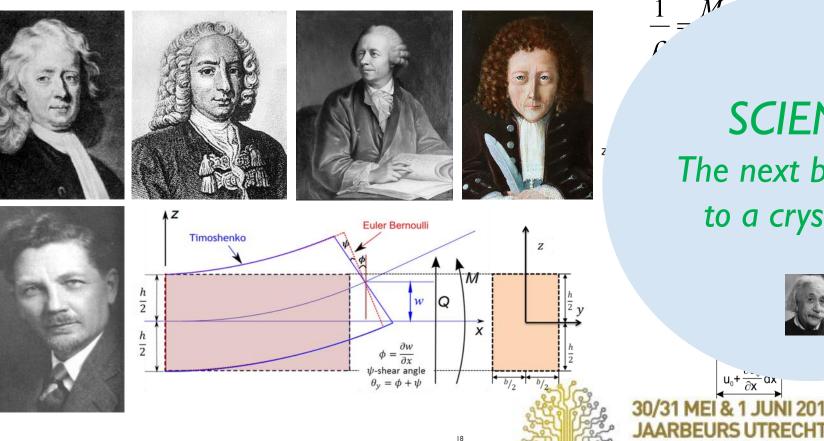


Willems, G., Thijs, S. & Vandevelde. 2012. Green IC Packaging: A threat to electronics reliability. Bits & Chips Hardware Conference.



HOW TO PREDICT? OR THIS WAY?

The Mechanics of Electronics



SCIENCE The next best thing to a crystal ball

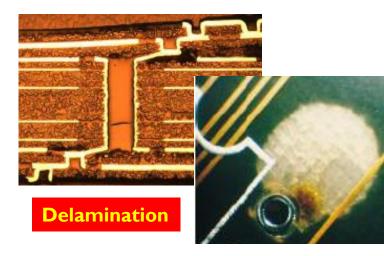
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Stress

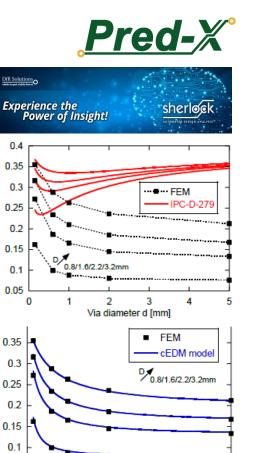
AN EXAMPLE OUT OF THE CEDM TOOLBOX PCBVIA LIFETIME AND DELAMINATION PREDICTION

PCB FR4 laminate:

- Cohesive) delamination and via failure
- Prediction of failure probability: production & operation
- >200 laminates: PCB Laminate Overview







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Via diameter d [mm]

3

0.4 0.35

0.3

0.25

0.2 0.15

0.1 0.05

0.35

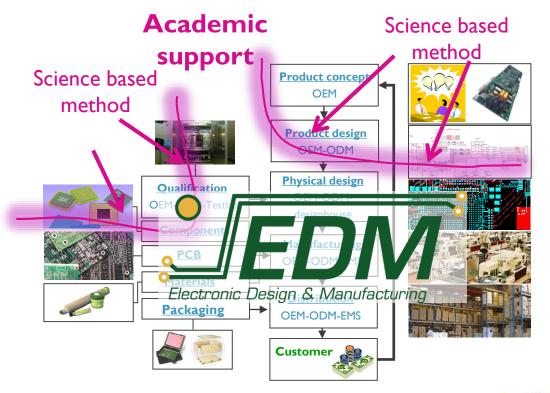
0.3

0.25 0.2 0.15 0.1 0.05

Axial strain $\epsilon_{c_{u,z}}$ [%]

Vxial strain ϵ_{ouz} [%]

A SCIENTIFIC APPROACH TO ELECTRONICS DESIGN & MANUFACTURING SCIENTIFIC/ACADEMIC SUPPORT



Experience-based industrial approach



Insufficient scientific basis and possibilities for education :

- PCB/PBA technology
- Substrate manufacturing
- Electronics assembly
- Test coverage
- Failure-mechanisms
- Design-for-X
- Reliability tests

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• etc.

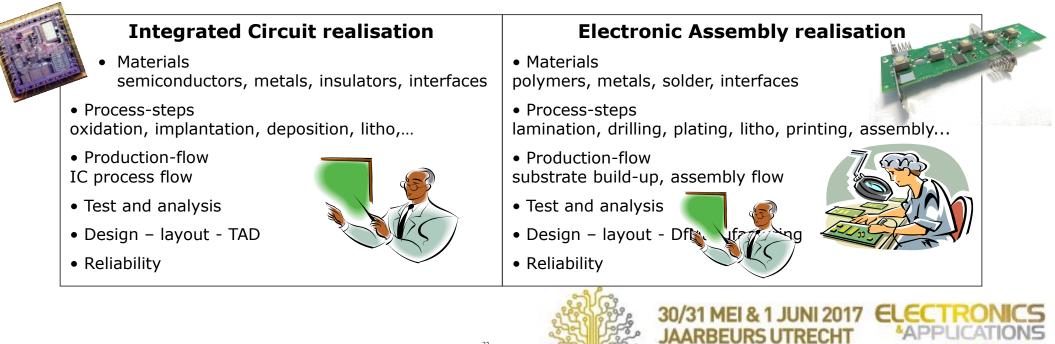
to handle challenges of complexity, quality and reliability

A SCIENTIFIC APPROACH TO ELECTRONICS DESIGN & MANUFACTURING

From experience to science based product development and manufacturing

IC realisation as a source of inspiration:

Each realisation element of an IC has a EA 'sibling'.



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Development: critical aspects

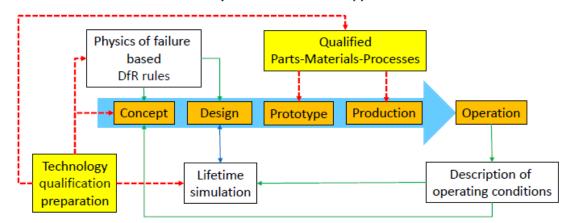
- Engineering cost
- Time-to-market

Minimize:

- Redesign
- Prototyping iterations: right first time
- Qualification failures

Maximize: PREDICTABILITY

Design-for-X guidelines & tools: virtual prototyping



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Physics of failure based approach

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Manufacturing: critical aspects

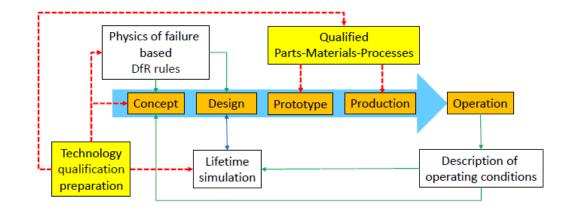
- Cost
- Volume ramp-up
- Delivery performance
- Quality

Maximize yield

Minimize labour

Minimize Work-in-Progress (test & repair)

Design-for-Manufacturing, Test, Cost, Logistics,...





A SCIENTIFIC APPROACH TO ELECTRONICS DESIGN & MANUFACTURING QUANTIFY – GUIDE – DIMENSION – PREDICT – PREPARE – EVALUATE

Design: selection and specification

- Components
- Substrates
- Materials

Physical design: layout

Manufacturing and assembly

- Manufacturing process flow
- Process set-up and compatibility
- Yield & test coverage & quality

Cost

Qualification

Simulation

Effective, physics based testing

New Product Introduction: fast, minimal cost, less & quantified risk

Operation

- Maintenance program
- Lifetime prediction
- Warranty costs cost of ownership

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You want to be successful with local design and manufacturing of new products?

There is no experience or history of the future.

Science is the only* tool available to prepare for future success.



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Dank u wel

Innec

embracing a better life



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